#### NCE N-Channel Enhancement Mode Power MOSFET

#### **DESCRIPTION**

The NCE0160S uses advanced trench technology and design to provide excellent  $R_{\rm DS(ON)}$  with low gate charge. This device is suitable for use in PWM, load switching and general purpose applications.

#### **GENERAL FEATURES**

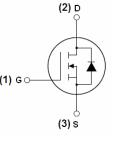
- $V_{DS} = 100V, I_D = 60A$  $R_{DS(ON)} < 16m\Omega @ V_{GS} = 12.6V$
- Special designed for Convertors and power controls
- High density cell design for ultra low Rdson
- Fully characterized Avalanche voltage and current
- Good stability and uniformity with high E<sub>AS</sub>
- Excellent package for good heat dissipation

### **Application**

- Power switching application
- Hard Switched and High Frequency Circuits
- Uninterruptible Power Supply

100% UIS TESTED!

100% ΔVds TESTED!



#### Schematic diagram



Marking and pin Assignment



PowerPAK SO-8 Bottom view

### **Package Marking And Ordering Information**

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
NCE0160	NCE0160S	PowerPAK SO-8	-	-	-

#### Absolute Maximum Ratings (TA=25℃unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	V <sub>DS</sub>	100	V
Gate-Source Voltage	V <sub>G</sub> s	±20	V
Drain Current-Continuous	I <sub>D</sub>	60	Α
Drain Current-Continuous(T <sub>C</sub> =70°ℂ)	I <sub>D</sub> (70°C)	50	Α
Pulsed Drain Current	I <sub>DM</sub>	80	Α
Maximum Power Dissipation	P <sub>D</sub>	105	W
Derating factor		0.70	W/℃
Single pulse avalanche energy (Note 5)	E <sub>AS</sub>	550	mJ
Operating Junction and Storage Temperature Range	$T_{J}$ , $T_{STG}$	-55 To 175	$^{\circ}$

#### **Thermal Characteristic**



## http://www.ncepower.com

# **NCE0160S**

Thermal Resistance, Junction-to- Case (Note 2)	R <sub>θJc</sub>	1.43	°C/W	1
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#### Electrical Characteristics (TA=25°C unless otherwise noted)

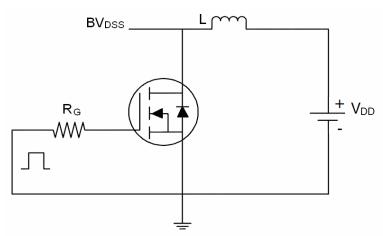
Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics	•		•			
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	V <sub>GS</sub> =0V I <sub>D</sub> =250μA	100	110	-	V
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> =100V,V <sub>GS</sub> =0V	-	-	1	μΑ
Gate-Body Leakage Current	I <sub>GSS</sub>	$V_{GS}$ =±20 $V$ , $V_{DS}$ =0 $V$	-	-	±100	nA
On Characteristics (Note 3)			•			
Gate Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS}=V_{GS}$ , $I_{D}=250\mu A$	2.5	3.7	4.5	V
Drain-Source On-State Resistance	R <sub>DS(ON)</sub>	V <sub>GS</sub> =10V, I <sub>D</sub> =30A	-	12.6	16	mΩ
Forward Transconductance	<b>g</b> FS	V <sub>DS</sub> =15V,I <sub>D</sub> =10A	-	30	-	S
Dynamic Characteristics (Note4)			•			
Input Capacitance	C <sub>lss</sub>	\/ -50\/\/ -0\/	-	2850	-	PF
Output Capacitance	C <sub>oss</sub>	$V_{DS}$ =50V, $V_{GS}$ =0V,	-	220	-	PF
Reverse Transfer Capacitance	C <sub>rss</sub>	F=1.0MHz	-	90	-	PF
Switching Characteristics (Note 4)	•		•			
Turn-on Delay Time	t <sub>d(on)</sub>		-	17	-	nS
Turn-on Rise Time	t <sub>r</sub>	$V_{DD}$ =30V, $I_D$ =5A, $R_L$ =10 $\Omega$	-	10	-	nS
Turn-Off Delay Time	t <sub>d(off)</sub>	$V_{GS}$ =10 $V$ , $R_{G}$ =1 $\Omega$	-	26	-	nS
Turn-Off Fall Time	t <sub>f</sub>		-	10	-	nS
Total Gate Charge	$Q_g$	\/ _F0\/   _40A	-	47	-	nC
Gate-Source Charge	$Q_{gs}$	$V_{DS}$ =50V, $I_{D}$ =10A, $V_{GS}$ =10V	-	13		nC
Gate-Drain Charge	$Q_{gd}$	V <sub>GS</sub> =10V	-	12.5	-	nC
Drain-Source Diode Characteristics			•			
Diode Forward Voltage (Note 3)	V <sub>SD</sub>	V <sub>GS</sub> =0V,I <sub>S</sub> =4A	-	-	1.2	V
Diode Forward Current (Note 2)	Is		-	-	60	Α
Reverse Recovery Time	t <sub>rr</sub>	TJ = 25°C, IF = 10A	-	-	60	nS
Reverse Recovery Charge	Qrr	di/dt = 100A/µs(Note3)	-	-	200	nC
Forward Turn-On Time	t <sub>on</sub>	Intrinsic turn-on time is negligible (turn-on is dominated by LS+LD)				

#### Notes:

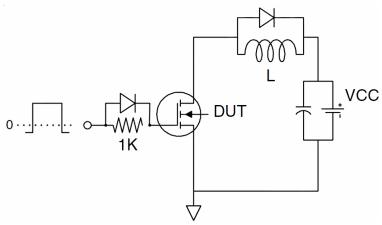
- 1. Repetitive Rating: Pulse width limited by maximum junction temperature.
- 2. Surface Mounted on FR4 Board, t ≤ 10 sec.
- **3.** Pulse Test: Pulse Width ≤  $300\mu$ s, Duty Cycle ≤ 2%.
- 4. Guaranteed by design, not subject to production
- **5.** EAS condition: Tj=25  $^{\circ}$ C,VDD=50V,VG=10V,L=0.5mH,Rg=25 $\Omega$

# **Test circuit**

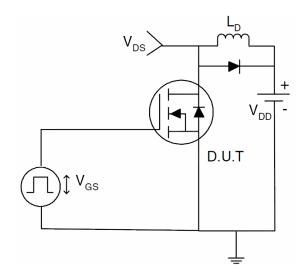
# 1) E<sub>AS</sub> test Circuits



#### 2) Gate charge test Circuit:



#### 3) Switch Time Test Circuit:



### TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS (curves)

# Figure 1. Safe operating area

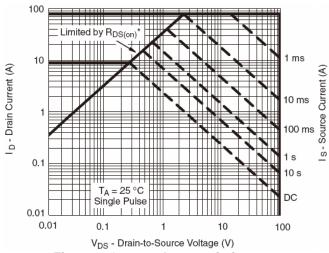
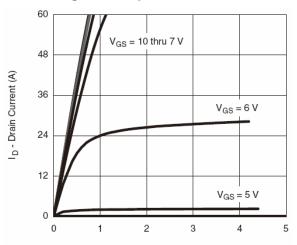


Figure3. Output characteristics



V<sub>DS</sub> - Drain-to-Source Voltage (V) Figure5. Static drain-source on resistance

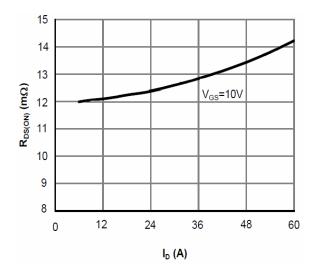


Figure 2. Source-Drain Diode Forward Voltage

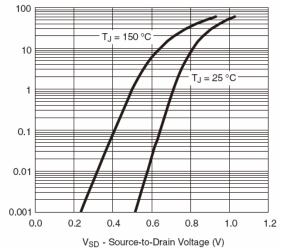


Figure 4. Transfer characteristics

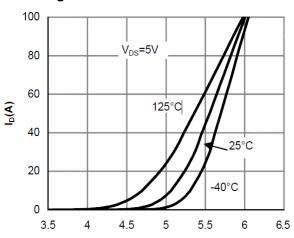
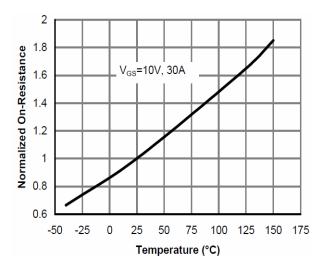


Figure 6. R<sub>DS(ON)</sub> vs Junction Temperature



#### Figure 7. BV<sub>DSS</sub> vs Junction Temperature

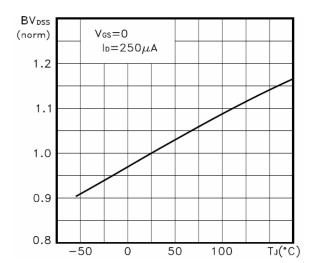


Figure 9. Gate charge waveforms

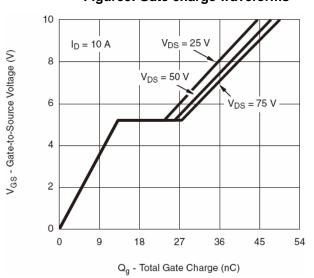


Figure 8. V<sub>GS(th)</sub> vs Junction Temperature

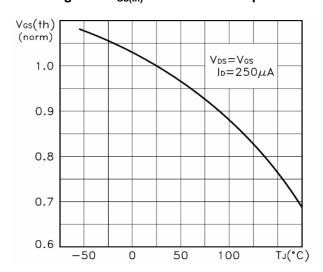


Figure 10. Capacitance

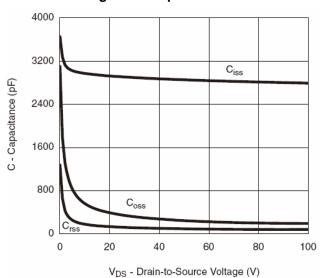
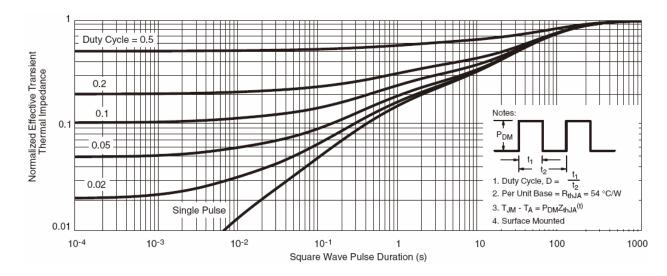


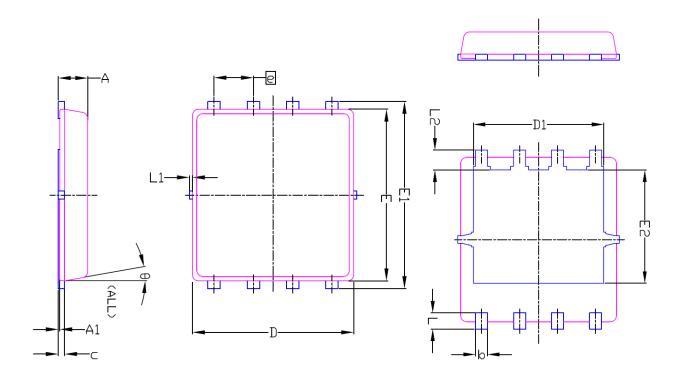
Figure 11. Normalized Maximum Transient Thermal Impedance



**Pb Free Product** 



# **PowerPAK SO-8 PACKAGE INFORMATION**



SYMBOLS	DIMENSIONS IN MILLIMETERS			DIMENSIONS IN INCHES			
2 I MBOL2	MIN	NOM	MAX	MIN	NOM	MAX	
A	0.85	0. 95	1.00	0. 033	0.037	0.039	
A1	0.00		0.05	0.000		0.002	
b	0.30	0.40	0.50	0.012	0.016	0.020	
С	0. 15	0. 20	0. 25	0.006	0.008	0.010	
D	5. 20 BSC			0.205 BSC			
D1	4.35 BSC			0.171 BSC			
Е	5. 55 BSC			0.219 BSC			
E1		6.05 BSC		0. 238 BSC 0. 150 BSC			
E2		3.82 BSC					
e		1.27 BSC		0.050 BSC			
L	0.45	0. 55	0.65	0.018	0.022	0.026	
L1	0		0.15	0		0.006	
L2	0.68 REF			0.027 REF			
θ	0°		10°	0°		10°	

**NCE0160S** 

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